



BAV199W

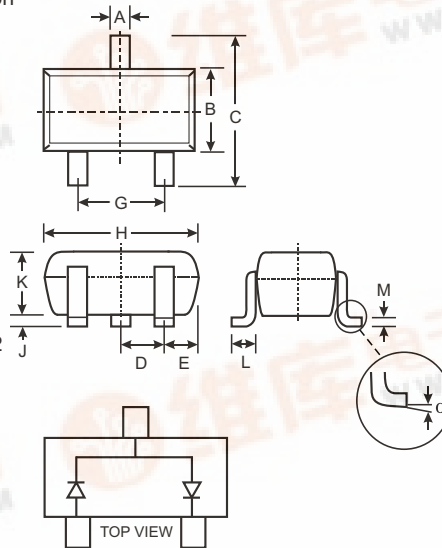
DUAL SURFACE MOUNT LOW LEAKAGE DIODE

Features

- Surface Mount Package Ideally Suited for Automatic Insertion
- Very Low Leakage Current
- Lead Free By Design/RoHS Compliant (Note 3)
- "Green Device" (Note 4)

Mechanical Data

- Case: SOT-323
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Finish Matte Tin Finish annealed over Alloy 42 leadframe. Solderable per MIL-STD-202, Method 208
- Polarity: See Diagram
- Marking: K52 & Date Code (See Page 2)
- Weight: 0.006 grams (approximate)



SOT-323		
Dim	Min	Max
A	0.25	0.40
B	1.15	1.35
C	2.00	2.20
D	0.65 Nominal	
E	0.30	0.40
G	1.20	1.40
H	1.80	2.20
J	0.0	0.10
K	0.90	1.00
L	0.25	0.40
M	0.10	0.18
	0	8
All Dimensions in mm		

Maximum Ratings @ T_A = 25 C unless otherwise specified

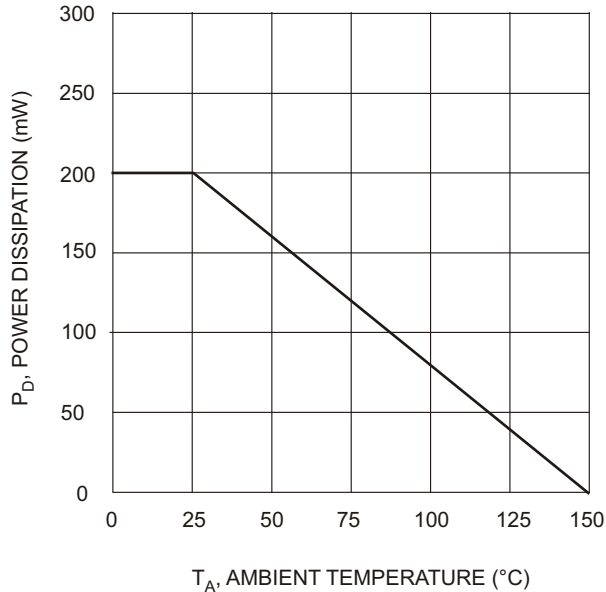
Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V _{RRM}	85	V
Working Peak Reverse Voltage	V _{RWM}		
DC Blocking Voltage	V _R		
RMS Reverse Voltage	V _{R(RMS)}	60	V
Forward Continuous Current (Note 2)	I _{FM}	160	mA
Single diode		140	
Repetitive Peak Forward Current (Note 2)	I _{FRM}	500	mA
Non-Repetitive Peak Forward Surge Current	I _{FSM}	4.0	A
@ t = 1.0 s		1.0	
@ t = 1.0ms		0.5	
Power Dissipation (Note 2)	P _d	200	mW
Thermal Resistance Junction to Ambient Air (Note 2)	R _{JA}	625	C/W
Operating and Storage Temperature Range	T _j , T _{STG}	-65 to +150	C

Electrical Characteristics @ T_A = 25 C unless otherwise specified

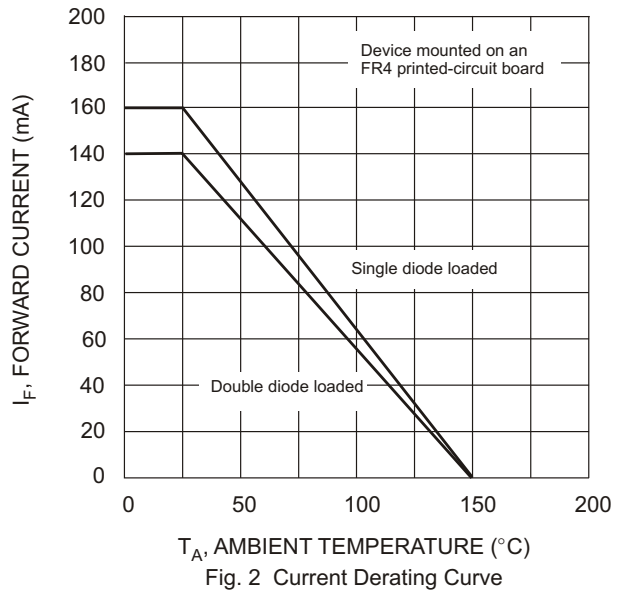
Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 1)	V _{(BR)R}	85			V	I _R = 100 A
Forward Voltage	V _F			0.90 1.0 1.1 1.25	V	I _F = 1.0mA I _F = 10mA I _F = 50mA I _F = 150mA
Leakage Current (Note 1)	I _R			5.0 80	nA nA	V _R = 75V V _R = 75V, T _j = 150 C
Total Capacitance	C _T		2		pF	V _R = 0, f = 1.0MHz
Reverse Recovery Time	t _{rr}			3.0	s	I _F = I _R = 10mA, I _{rr} = 0.1 x I _R , R _L = 100

- Notes:
- Short duration test pulse to minimize self-heating effect.
 - Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at <http://www.diodes.com/datasheets/ap02001.pdf>.
 - No purposefully added lead.
 - Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.

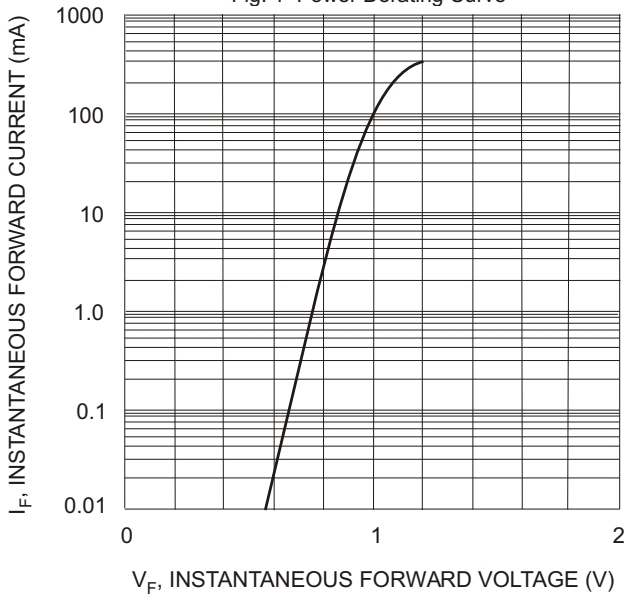




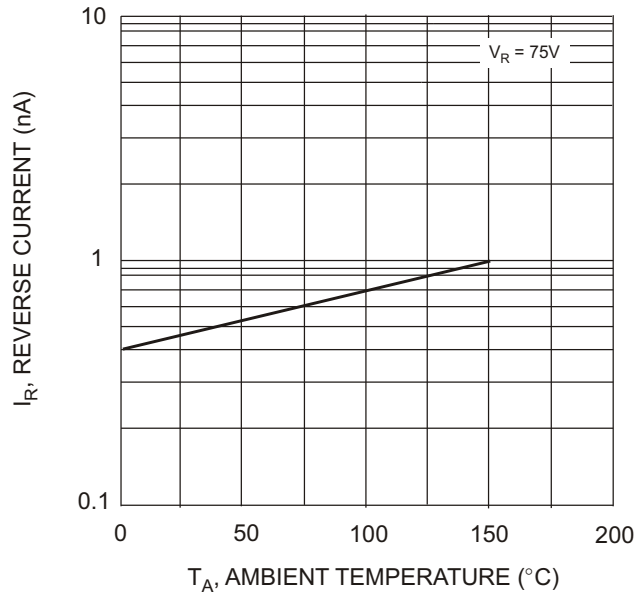
T_A , AMBIENT TEMPERATURE (°C)
Fig. 1 Power Derating Curve



T_A , AMBIENT TEMPERATURE (°C)
Fig. 2 Current Derating Curve



V_F , INSTANTANEOUS FORWARD VOLTAGE (V)
Fig. 3 Typical Forward Characteristics



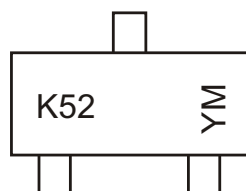
T_A , AMBIENT TEMPERATURE (°C)
Fig. 4 Typical Reverse Characteristics

Ordering Information (Note 5)

Device	Packaging	Shipping
BAV199W-7	SOT-323	3000/Tape & Reel

Notes: 5. For Packaging Details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

Marking Information



K52 = Product Type Marking Code
YM = Date Code Marking
Y = Year ex: T = 2006
M = Month ex: 9 = September

Date Code Key

Year	2004	2005	2006	2007	2008	2009	2010	2011	2012			
Code	R	S	T	U	V	W	X	Y	Z			
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D



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